

# SHANGHAI SUNRISE ELECTRONICS CO., LTD.

### SS32 THRU SS36

## SURFACE MOUNT SCHOTTKY **BARRIER RECTIFIER**

**TECHNICAL SPECIFICATION** 

**VOLTAGE: 20 TO 60V CURRENT: 3.0A** 

#### **FEATURES**

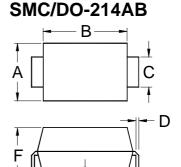
- Ideal for surface mount pick and place application
- Low profile package
- Low power loss, high efficiency
- High current capability, low V<sub>F</sub>
- High surge capability
- High temperature soldering guaranteed: 260°C/10sec/at terminal

#### **MECHANICAL DATA**

 Terminal: Plated leads solderable per MIL-STD 202E, method 208C

 Case: Molded with UL-94 Class V-O recognized flame retardant epoxy

Polarity: Color band denotes cathode



			-1		
	Α	В	С	D	
MAX.	.245(6.22)	.280(7.11)	.124(3.15)	.012(0.305)	
MIN.	.220(5.59)	.260(6.60)	.108(2.75)	.006(0.152)	
	Ė	F	Ğ	H	
MAX.	.320(8.13)		.008(0.203)		
MIN	305(7.75)	084(2 13)	004/0 102	030(0.76)	

Dimensions in inches and (millimeters)

### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Single-phase, half-wave, 60Hz, resistive or inductive load rating at 25°C, unless otherwise stated, for capacitive load, derate current by 20%)

RATINGS	SYMBOL	SS32	SS33	SS34	SS35	SS36	UNITS
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	20	30	40	50	60	V
Maximum RMS Voltage	$V_{RMS}$	14	21	28	35	42	V
Maximum DC Blocking Voltage	$V_{DC}$	20	30	40	50	60	V
Maximum Average Forward Rectified Curren	t I <sub>F(AV)</sub>	3.0					Α
(T <sub>L</sub> =100°C)							
Peak Forward Surge Current (8.3ms single	1	100					А
half sine-wave superimposed on rated load)	I <sub>FSM</sub>						
Maximum Instantaneous Forward Voltage	$V_{F}$	0.5			0.7		V
(at rated forward current)	VF	0.3					V
Maximum DC Reverse Current T <sub>a</sub> =25°	C ,	0.5					mA
(at rated DC blocking voltage) T <sub>a</sub> =100°	C I <sub>R</sub>	20.0					mA
Typical Junction Capacitance (Note	1) C <sub>J</sub>	300					pF
Typical Thermal Resistance (Note:	2) R <sub>θ</sub> (ja)	15					°C/W
Storage and Operation Junction Temperature		-65 to +150					°C
Mata		-					

- 1.Measured at 1.0 MHz and applied voltage of 4.0V<sub>dc</sub>
- 2. Thermal resistance from junction to terminal mounted on 5×5mm copper pad area